

SMD Auto COG, Ceramic, 330 pF, 5%, 250 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Automotive Grade, 0603



Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.07mm
S	0.7mm MIN
B	0.35mm +/-0.15mm

Packaging Specifications	
Packaging:	T&R, 180mm, Paper Tape
Packaging Quantity:	4000

General Information	
Series:	SMD Auto COG
Style:	SMD Chip
Description:	SMD, MLCC, Ultra-Stable, Low Loss, Automotive Grade
Features:	Ultra-Stable, Low Loss, Automotive Grade
RoHS:	Yes
Termination:	Tin
Marking:	No
Qualifications:	AEC-Q200
AEC-Q200:	Yes
Component Weight:	3700 ug
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	330 pF
Measurement Condition:	1 MHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	250 VDC
Dielectric Withstanding Voltage:	625 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor:	0.1% 1 MHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.